

## C0603C759BATACTU

Aliases (C0603C759BATAC7867)

SMD Comm X8G HT150C, Ceramic, 7.5 pF, +/-0.1 pF, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0603, 0.5 mm



General Information			
Series	SMD Comm X8G HT150C		
Style	SMD Chip		
Description	SMD, MLCC, High Temperature, Ultra-Stable		
Features	High Temperature, Ultra-Stable		
RoHS	Yes		
Termination	Tin		
Marking	No		
AEC-Q200	No		
Typical Component Weight	3.7 mg		
Shelf Life	78 Weeks		
MSL	1		

Dimensions		
Chip Size	0603	
L	1.6mm +/-0.15mm	
W	0.8mm +/-0.15mm	
Т	0.8mm +/-0.07mm	
S	0.5mm MIN	
В	0.35mm +/-0.15mm	

VV	0.8mm +/-0.15mm			
Т	0.8mm +/-0.07mm			
S	0.5mm MIN			
В	0.35mm +/-0.15mm			
Packaging Specifications				

4000

Packaging

Packaging Quantity

T&R, 180mm, Paper Tape

Specifications		
Capacitance	7.5 pF	
Measurement Condition	1 MHz 1.0Vrms	
Tolerance	+/-0.1 pF	
Voltage DC	250 VDC	
Dielectric Withstanding Voltage	625 VDC	
Temperature Range	-55/+150°C	
Temp. Coefficient	X8G	
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms	
Dissipation Factor	0.1% 1 MHz 1.0Vrms	
Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours	
Insulation Resistance	100 GOhms	

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